

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	110m Ω @10V	5A

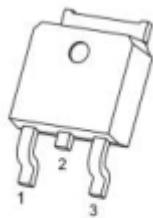
Feature

- V_{DS} 100V
- I_D 5A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) < 140 mohm

Application

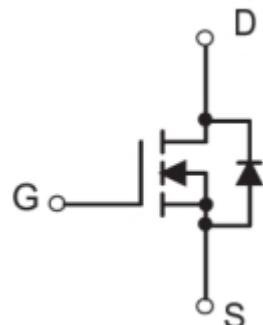
- Consumer electronic power supply
- Motor control
- Synchronous-rectification
- Isolated DC/DC convertor
- Invertors

Package



TO-252(1:G 2:D 3:S)

Circuit diagram



Marking



010N110G =Device Code

**** =Week Code**

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	5	W
Drain Current – Pulsed ¹	I_{DM}	20	A
Power Dissipation ($T_C=25^\circ\text{C}$)	P_D	55	W
Thermal Resistance Junction to ambient	$R_{\theta JA}$	2.7	$^\circ\text{C}/\text{W}$
Storage Temperature Range	T_{STG}	-55~ +150	$^\circ\text{C}$
Operating Junction Temperature Range	T_J	-55~ +150	$^\circ\text{C}$

Electrical characteristics

($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100	110		V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate threshold voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1	1.8	2.5	V
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			100	μA
Static Drain-Source on-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10\text{V}, I_D = 3\text{A}$		110	140	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 2\text{A}$		160	300	
Dynamic characteristics⁴						
Total Gate Charge	Q_g	$V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 50\text{V}, I_D = 3.0\text{A}$		4.3		nC
Gate-Source Charge	Q_{gs}			1.5		
Gate-Drain Charge	Q_{gd}			1.1		
Turn-On Delay Time	$T_{\text{d(on)}}$	$V_{\text{GS}} = 10\text{V}, V_{\text{DD}} = 50\text{V}, I_D = 3.0\text{A}, R_{\text{GEN}} = 2\Omega$		14.7		nS
Rise Time	T_r			3.5		
Turn-Off Delay Time	$T_{\text{d(off)}}$			20.9		
Fall Time	T_f			2.7		
Input Capacitance	C_{iss}	$V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		206		pF
Output Capacitance	C_{oss}			29		
Reverse Transfer Capacitance	C_{rss}			3.3		
Drain-Source Diode Characteristics						
Continuous Source Current	I_s	$V_G = V_D = 0\text{V}$, Force Current			8	A
Diode forward voltage	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = 3\text{A}, T_J = 25^\circ\text{C}$			1.2	V

Typical Characteristics

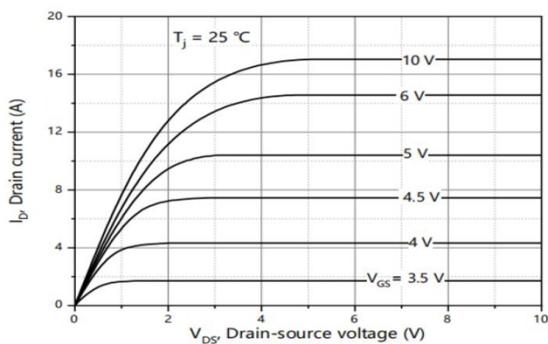


Figure 1. Output Characteristics

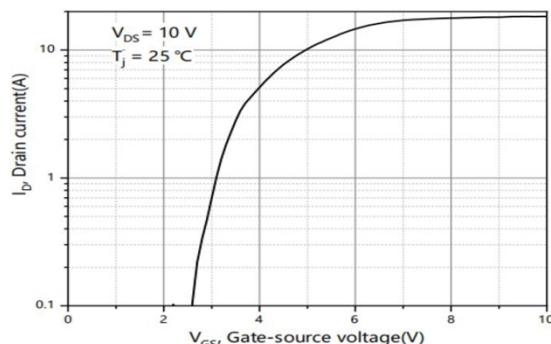


Figure 2. Transfer Characteristics

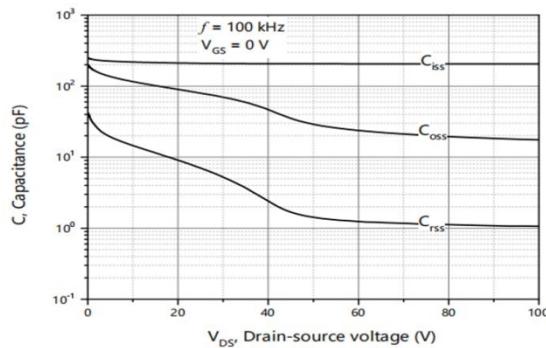


Figure 3. Capacitance Characteristics

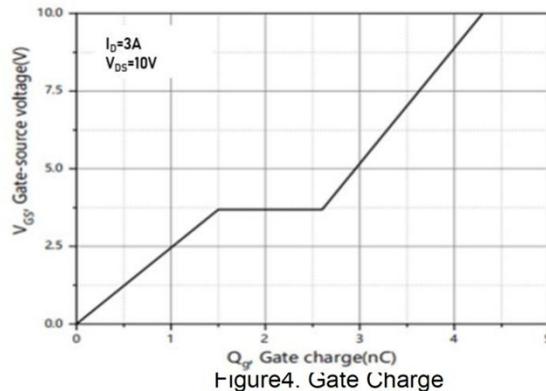


Figure 4. Gate Charge

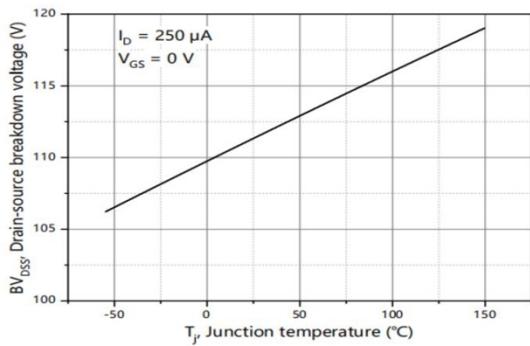


Figure 5. Drain-Source breakdown voltage

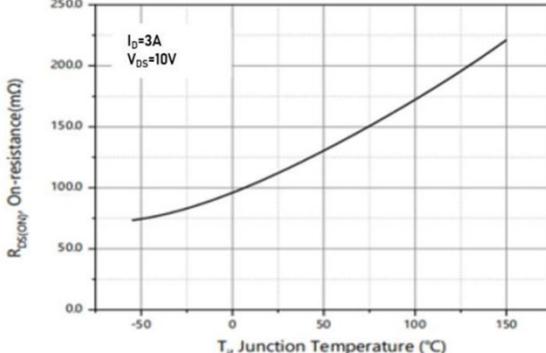


Figure 6. Drain-Source on Resistance

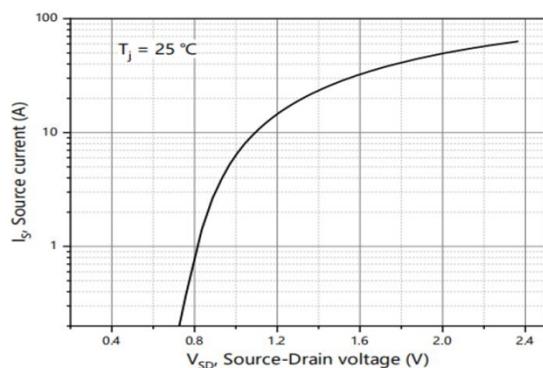


Figure 7. Forward characteristic of body diode

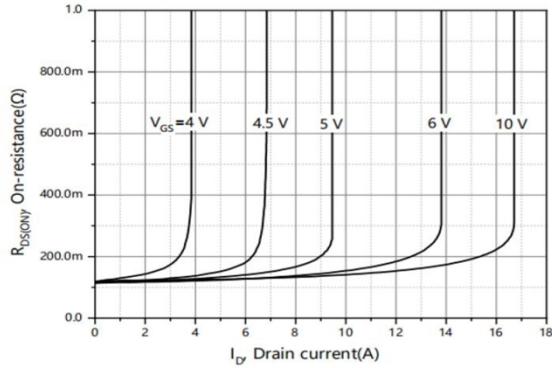


Figure 8. Drain-source on-state resistance

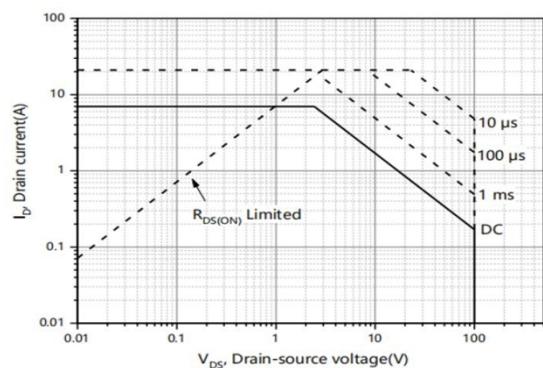
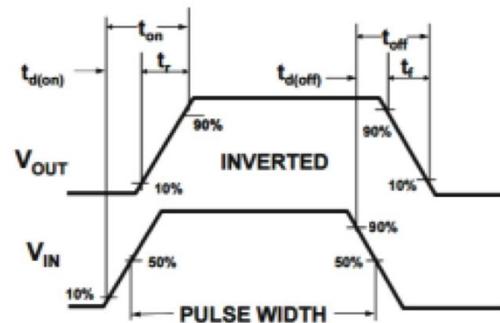
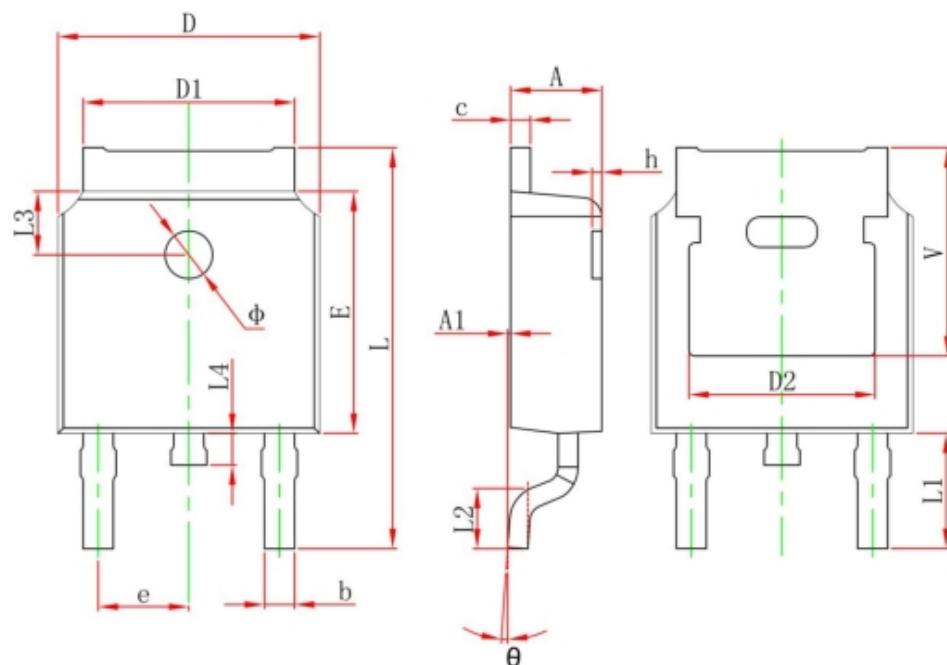

 Figure9. Safe Operation Area $T_A=25\text{ }^{\circ}\text{C}$


Figure10. Switching wave

TO-252-2L(4R) Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
ϕ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	